



TRR[®]

AO3400

30V N-Channel Enhancement Mode MOSFET

AO3400 N-Channel Enhancement Mode Field Effect Transistor

VDS= 30V

RDS(ON), Vgs@10V, Ids@5.8A < 28mΩ

RDS(ON), Vgs@4.5V, Ids@5.0A < 33mΩ

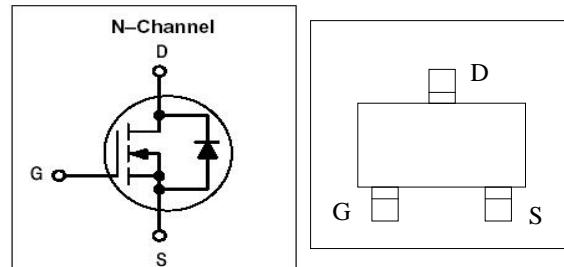
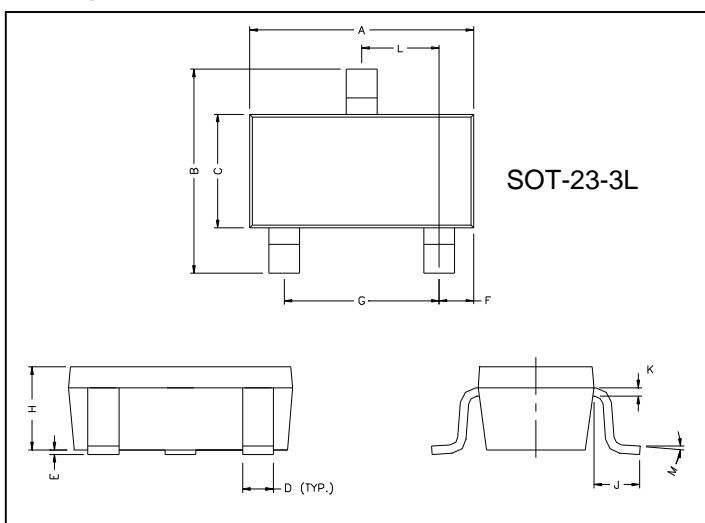
RDS(ON), Vgs@2.5V, Ids@4.0A < 52mΩ

Features

Advanced trench process technology

High Density Cell Design For Ultra Low On-Resistance

Package Dimensions



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.70	3.10	G	1.90	REF.
B	2.65	2.95	H	1.00	1.30
C	1.50	1.70	K	0.10	0.20
D	0.35	0.50	J	0.40	-
E	0	0.10	L	0.85	1.15
F	0.45	0.55	M	0°	10°

Maximum Ratings and Thermal Characteristics (TA = 25°C unless otherwise noted)

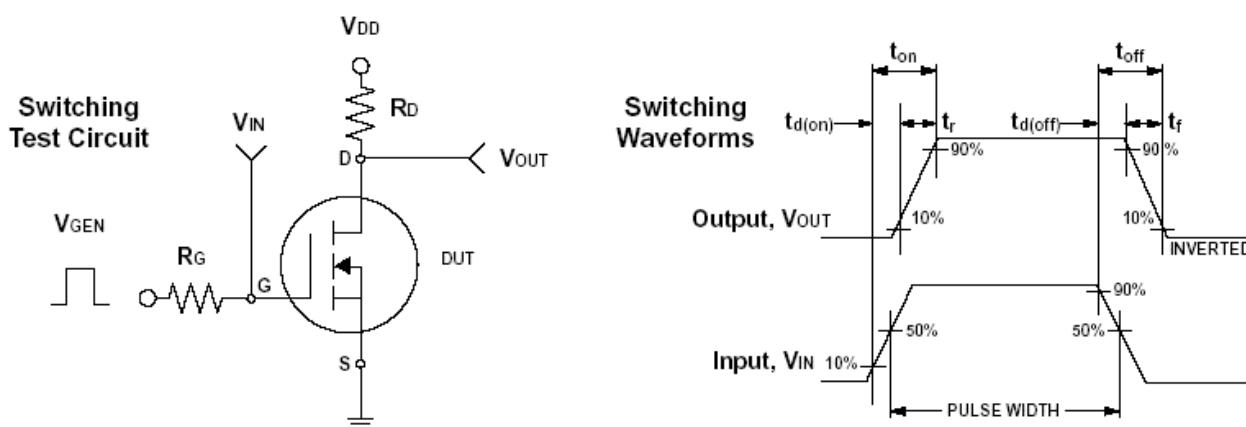
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	± 12	
Continuous Drain Current	I _D	5.8	A
Pulsed Drain Current	I _{DM}	30	
Maximum Power Dissipation	P _D	1.4	W
		1	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C
Junction-to-Ambient Thermal Resistance (PCB mounted)	R _{θJA}	145	°C/W



ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Miax.	Unit
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250μA	30			V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 5.8A V _{GS} = 4.5V, I _D = 5A V _{GS} = 2.5V, I _D = 4A	22.0	28.0		mΩ
Drain-Source On-State Resistance	R _{DS(on)}		27.0	33.0		
Drain-Source On-State Resistance	R _{DS(on)}		43.0	52.0		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	0.7		1.4	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V			1	μA
Gate Body Leakage	I _{GSS}	V _{GS} = ± 12V, V _{DS} = 0V			±100	nA
Forward Transconductance	g _f	V _{DS} = 5V, I _D = 5A	10	15	—	S
Gate Resistance	R _g	F=1.0MHz	6	7	7.5	Ω
Dynamic						
Total Gate Charge	Q _g	V _{DS} = 15V, I _D = 5.8A V _{GS} = 4.5V	11	14		nC
Gate-Source Charge	Q _{gs}		1.6			
Gate-Drain Charge	Q _{gd}		2.8			
Turn-On Delay Time	t _{d(on)}	V _{DD} = 15V, RL=2.7Ω I _D = 1A, V _{GEN} = 10V R _G = 3Ω	7	11		ns
Turn-On Rise Time	t _r		15	20		
Turn-Off Delay Time	t _{d(off)}		38	50		
Turn-Off Fall Time	t _f		3	10		
Input Capacitance	C _{iss}	V _{DS} = 10V, V _{GS} = 0V f = 1.0 MHz	340			pF
Output Capacitance	C _{oss}		115			
Reverse Transfer Capacitance	C _{rss}		33			
Source-Drain Diode						
Max. Diode Forward Current	I _s				1.6	A
Diode Forward Voltage	V _{SD}	I _s = 1.6A, V _{GS} = 0V			1.2	V

Note: Pulse test: pulse width <= 300μs, duty cycle <= 2%





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Characteristics Curve

